



## STC Chicago Scholarship Application – High School

Thank you for your interest in the STC Chicago Student Scholarship. Please send an email with any questions to [scholarship@stc-chicago.com](mailto:scholarship@stc-chicago.com).

### Application Materials

To apply for the STC Chicago Scholarship, please submit the following items to [scholarship@stc-chicago.com](mailto:scholarship@stc-chicago.com).

- A completed Scholarship Application form
- A faculty signature confirming that the applicant is a student in good standing with the GPA shown on the application form
- Technical Writing Exercise: See the *Technical Writing Exercise* document for details.
- A one to three paragraph description of your career interest in the field of technical communication including an explanation of why you chose this field

### How to Apply

Please return the completed application materials to [scholarship@stc-chicago.com](mailto:scholarship@stc-chicago.com). We will send a confirmation email for all entries received.

**Note:** If you do not receive a confirmation, please contact [scholarship@stc-chicago.com](mailto:scholarship@stc-chicago.com).

### Evaluation Criteria

The STC Chicago Scholarship panel evaluates applicants based on the writing quality demonstrated in the Technical Writing Exercise and career interest description.

STC Chicago reserves the right not to award a scholarship if they become aware or have reasonable grounds to believe that an applicant is not eligible. They also reserve the right not to award the scholarship in the event that there are no applicants that demonstrated adequate skills in the Technical Writing exercise or no applicants fully meet the application criteria.

### Scholarship Schedule

Applications must be received by email on or before March 31, 2021. Applicants are notified of the scholarship award decisions by April 30, 2021. Scholarship award payment will be made directly to the educational institution.



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## Personal Information

<b>Name</b>			
	<b>First</b>	<b>Middle</b>	<b>Last</b>
<b>Mailing Address</b>			
	<b>Street address</b>		
	<b>City</b>	<b>State</b>	<b>ZIP code</b>
<b>Telephone</b>			
<b>Home or Personal E-mail Address, not a school email address</b>			

## Education

<b>High School</b>	
<b>Cumulative GPA, 4.0 scale</b>	
<b>Anticipated Academic Institution</b>	
<b>Status for Upcoming School Year full- or part-time</b>	

## Applicant Waiver

*I hereby affirm that the information provided in this application packet is true and accurate and that the Technical Writing exercise work is my own. My Technical Writing exercise does not contain classified or proprietary information, or copyrighted material.*

*I understand the contents of the application packets will be kept confidential among the members of the Scholarship review panel and will not be returned to me.*

**Applicant Name, printed:** \_\_\_\_\_

**Applicant Signature:** \_\_\_\_\_ **Date:** \_\_\_\_\_

## Faculty Waiver

*I hereby affirm that the applicant is a student in good standing with the GPA shown in this application.*

**Faculty Name, printed:** \_\_\_\_\_

**Faculty Signature:** \_\_\_\_\_ **Date:** \_\_\_\_\_